

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: KPGF-1011GBRC-120

Green
Blue
Hyper-Red

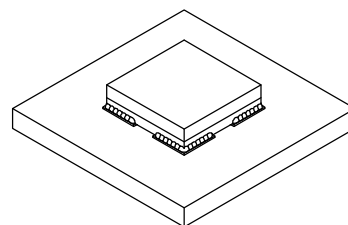
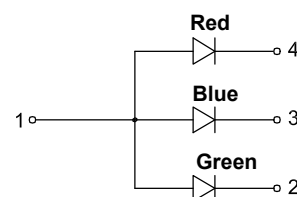
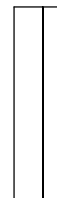
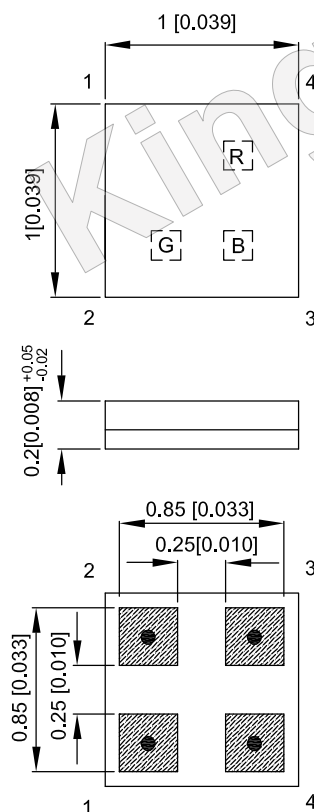
Features

- 1.0mmX1.0mm SMD LED, 0.2mm thickness.
- Low power consumption.
- Package : 4000pcs / reel.
- Moisture sensitivity level : level 3.
- Low current IF=5mA operating.
- RoHS compliant.

Descriptions

- The Green source color devices are made with InGaN on SiC substrate Light Emitting Diode.
- The Blue source color devices are made with InGaN on SiC substrate Light Emitting Diode.
- The Hyper-Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.1 (0.004") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.



Selection Guide

Part No.	Emitting Color (Material)	Lens Type	Iv (mcd) [2] @ 5mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
KPGF-1011GBRC-120	Green (InGaN)	Water Clear	50	80	150°
	Blue (InGaN)		10	23	
	Hyper-Red (AlGaInP)		15	30	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous Flux: +/-15%.
3. Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green Blue Hyper-Red	518 461 632		nm	IF=5mA
λD [1]	Dominant Wavelength	Green Blue Hyper-Red	527 467 624		nm	IF=5mA
Δλ1/2	Spectral Line Half-width	Green Blue Hyper-Red	35 22 20		nm	IF=5mA
C	Capacitance	Green Blue Hyper-Red	100 110 25		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green Blue Hyper-Red	3 2.9 1.95	3.2 3.1 2.3	V	IF=5mA
IR	Reverse Current	Green Blue Hyper-Red		50 50 10	uA	VR=5V

Notes:

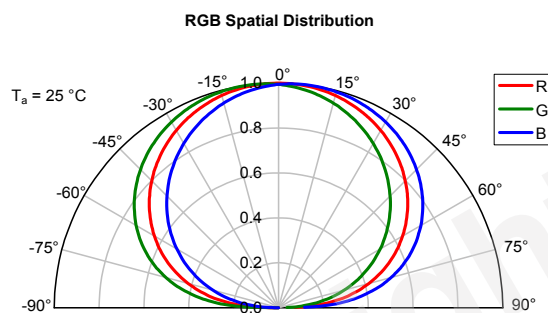
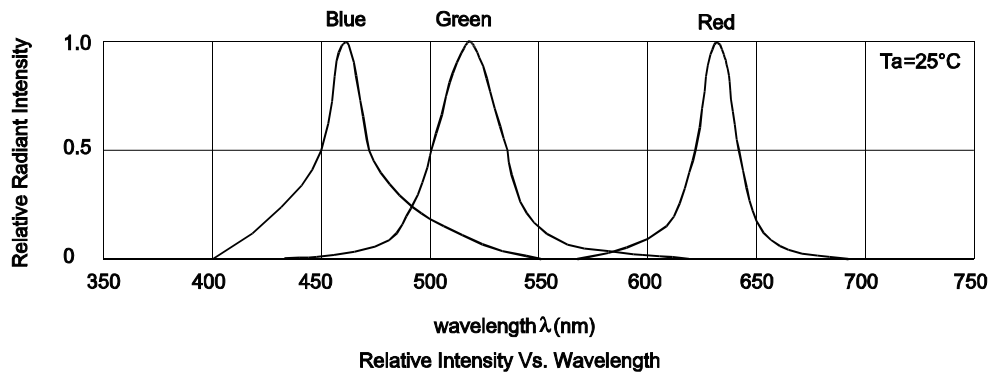
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

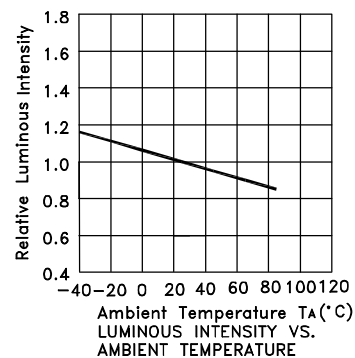
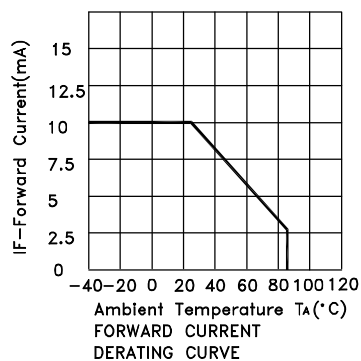
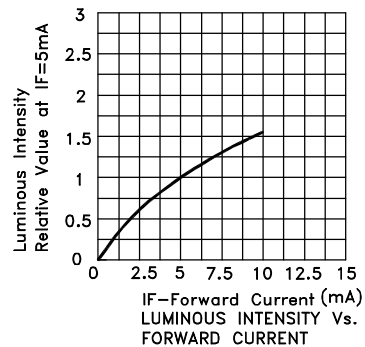
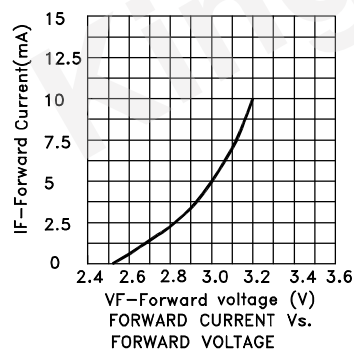
Parameter	Green	Blue	Hyper-Red	Units
Power dissipation [1]	35			mW
DC Forward Current [2]	10	10	10	mA
Peak Forward Current [3]	50	50	50	mA
Electrostatic Discharge Threshold (HBM)	1000	1000	3000	V
Reverse Voltage	5			V
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +100°C			

Notes:

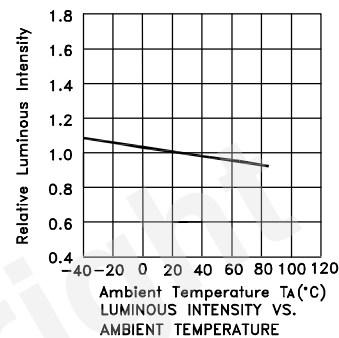
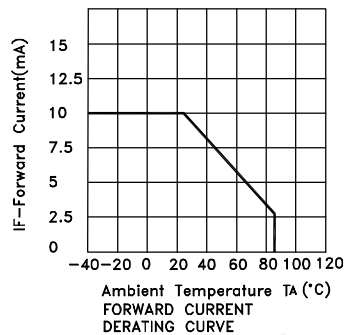
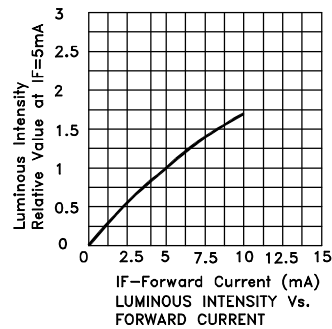
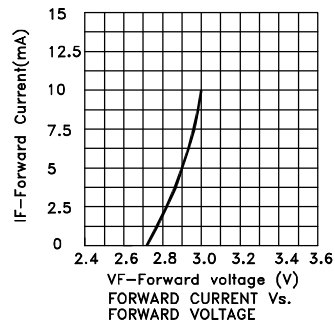
1. Within 35mW when multiple chips are lightened
2. The maximum ratings are valid for the case of lighting a single chip
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings
When three chips are lit at the same time, each chip should be driven at a current lower than 30% of the absolute maximum ratings
3. Duty Cycle 1/20, Pulse Width=1ms.
4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



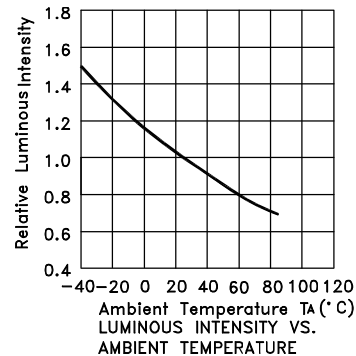
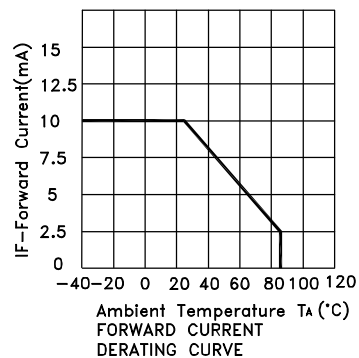
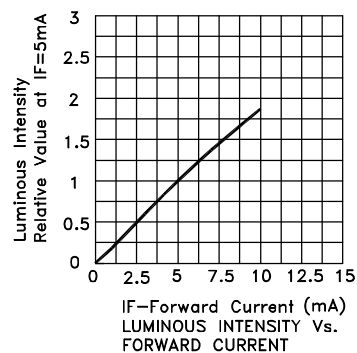
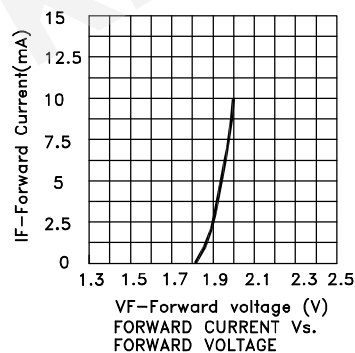
KPGF-1011GBRC-120 Green



Blue



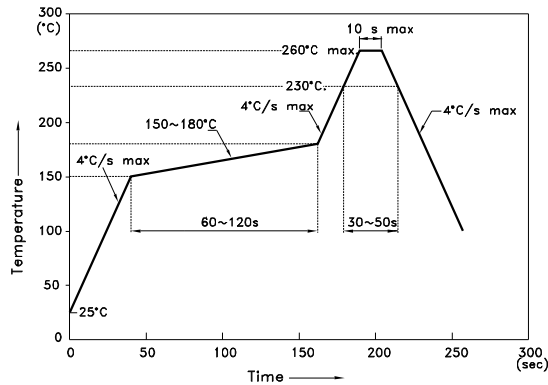
Hyper-Red



KPGF-1011GBRC-120

Reflow soldering is recommended and the soldering profile is shown below.
Other soldering methods are not recommended as they might cause damage to the product.

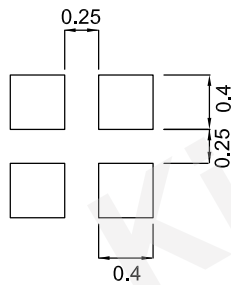
Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

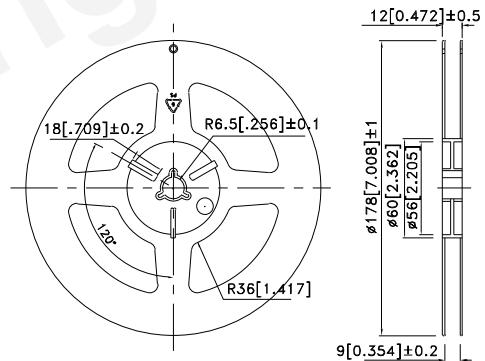
1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

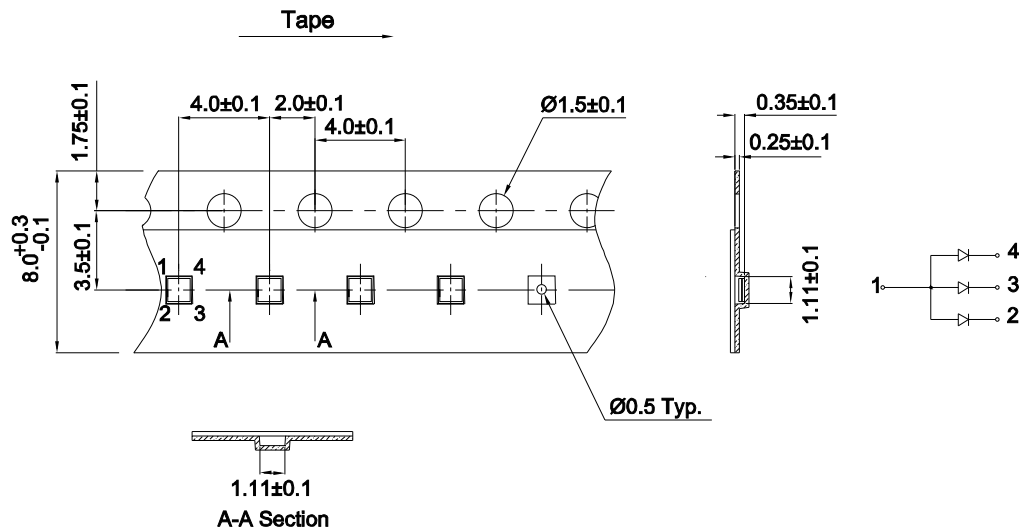


Mask open area ratio:80%;
Mask thickness:80~100um;

Reel Dimension

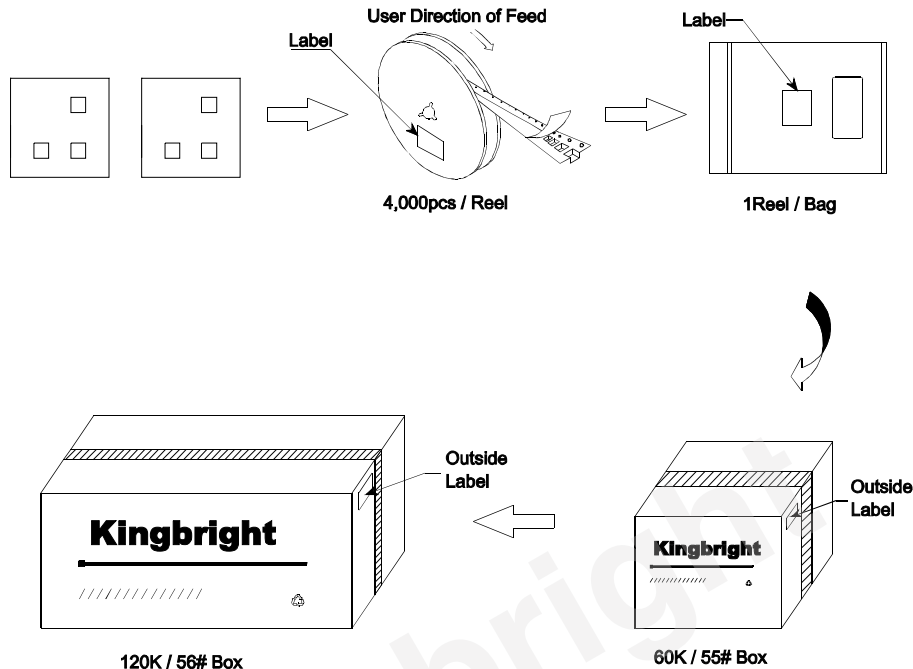


Tape Dimensions (Units : mm)



PACKING & LABEL SPECIFICATIONS

KPGF-1011GBRC-120



Kingbright		XXXXXXXXXX-XXXX	
P/NO: XXXXXXXX			
QTY: XXXXpcs			
S/N: XXXX			
CODE: XXX			
COUNTRY: CN		QC DATE: XXX XX XXXX PASSED	
LOT NO:			
XXXXXXXXXX-XXXX			
		1	RoHS Compliant

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